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Superconducting Fault Current Limiters: Theories, Technologies, Applications and Field Experience

Guest Editor:

Dr. Lei Chen

School of Electrical Engineering
and Automation, Wuhan
University, Wuhan 430072, China

Deadline for manuscript
submissions:

closed (10 September 2023)

Message from the Guest Editor

With the rapid development of high-temperature superconducting (HTS) materials, superconducting power applications have attracted increasing attention in the power industry, particularly for electrical systems with a high proportion of renewable energies. Superconducting fault current limiters (SFCLs) have obtained many successful engineering projects around the world and can be regarded as an extremely potential solution to assist electrical systems against fault inrushes.

The purpose of this Special Issue is to provide a platform for presenting the latest research results on superconducting fault current limiters. This Special Issue covers but is not limited to theories, technologies, applications, and field experience of SFCLs. We seek original research papers on theoretical, methodological, and empirical studies, as well as review papers that provide a critical overview on the state of the art of technologies. This Special Issue is open to all types of SFCLs, such as resistive type, inductive type, flux-coupling type, and saturated core type. It is also open to all voltage classes of power system protection with SFCLs.



mdpi.com/si/108720

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Prof. Dr. Maryam Tabrizian

1. Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada

2. Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

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Contact Us

Materials Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

Tel: +41 61 683 77 34
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